Abstract:

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present invention relates to method а suppressing mold formation on building parts using hydrophobic substances, wherein a dispersion hydrophobic particles having a mean particle diameter of from 0.005 to 5 μm in an organic dispersant is applied to the surface to be protected from mold attack and the dispersant is then removed, and to a composition for building parts which inhibits mold growth and comprises from 0.1 to 10% by weight of hydrophobic particles having a mean particle diameter from 0.005 to 5 µm dispersed in an organic dispersant.